

SPECIFICATION FOR LCD MODULE

MODULE NO: AFK480800A0-4.3INTM REVISION NO: V02

Customer's Approvai:		
		T
	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
CHECKED BY		
APPROVED BY		

Tel: (425)698-1938 Fax: (425)698-1852

Records of Revision

DATE	REF.PAGE PARAGRAPH DRAWING No.	REVISED No.	SUMMARY	REMARK
2017-05-15		V01	First Issue	
2017-06-02		V02	Update the drawings	

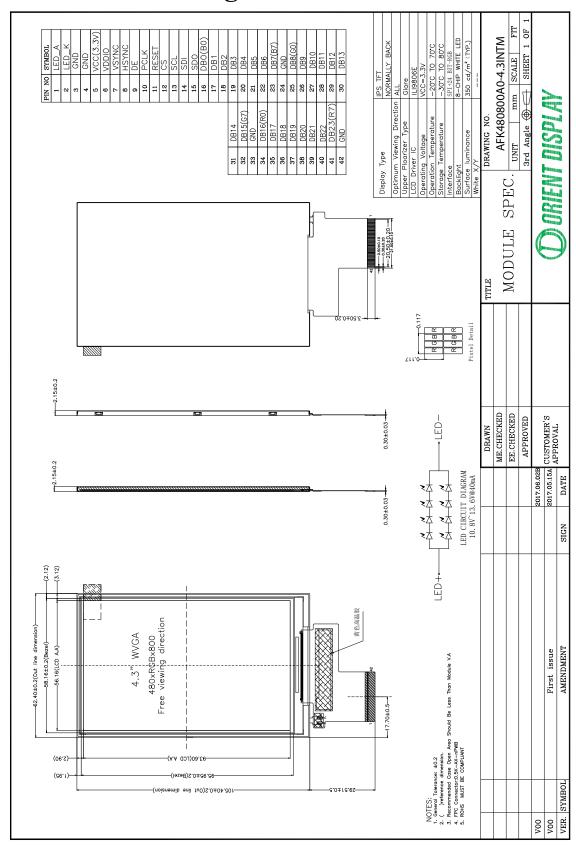
Contents

1. General Specification.	4
2. Mechanical Drawing	5
3. Block Diagram	6
4. Interface Pin Function.	7
5. Absolute Maximum Ratings	9
6. Electrical Characteristics.	10
7. Optical Characteristics	11
8. Timing Characteristics	14
9. Standard Specification for Reliability	16
10. Specification of Quality Assurance	18
11. Handling Precaution	27
12. Packing Method.	27

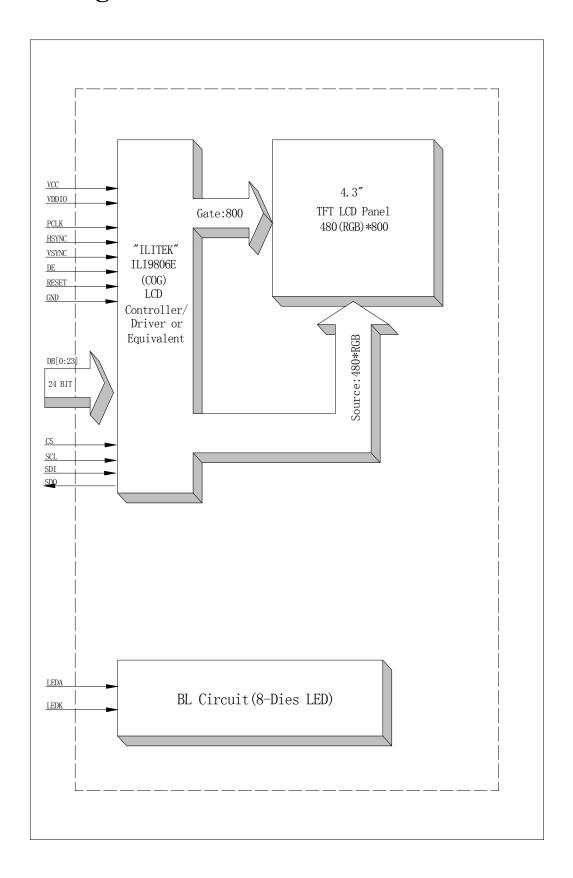
1. General Specification

Item	Contents	Unit
LCD TYPE	TFT/TRANSMISSIVE	
MODULE SIZE (W*H*T)	62.40*105.40*2.15	MM
ACTIVE SIZE (W*H)	56.16*93.60	MM
PIXEL PITCH (W*H)	0.117*0.117	MM
NUMBER OF DOTS	480*800	
DIVER IC	ILI9806E	
INTERFACE TYPE	SPI+24 BIT RGB	
TOP POLARIZER TYPE	GLARE	
RECOMMEND VIEWING DIRECTION	ALL	O'CLOCK
GRAY SCALE INVERSION DIRECTION	-	O'CLOCK
BACKLIGHT TYPE	8-LED WHITE	
TOUCH PANEL TYPE	WITHOUT	

2. Mechanical Drawing



3. Block Diagram



4. Interface Pin Function

Pin No.	Symbol	Description
1	LEDA	Anode of LED back light
2	LEDK	Cathode of LED back light
3	GND	Power ground
4	GND	Power voltage
5	VCC(3.3V)	Power supply
6	VDDIO	Power supply
7	VSYNC	Vertical sync signal
8	HSYNC	Horizontal sync signal
9	DE	Data enable
10	PCLK	Pixel clock
11	RESET	Reset pin
12	CS	Chip select signal input terminal, active at"L"
13	SCL	Serial clock
14	SDI	Serial data input pin
15	SDO	Serial data output pin
16	DB0(B0)	Blue data(LSB)
17	DB1	Blue data
18	DB2	Blue data
19	DB3	Blue data
20	DB4	Blue data
21	DB5	Blue data
22	DB6	Blue data
23	DB7(B7)	Blue data(MSB)
24	GND	Power ground
25	DB8(G0)	Green data (LSB)
26	DB9	Green data
27	DB10	Green data
28	DB11	Green data
29	DB12	Green data
30	DB13	Green data
31	DB14	Green data
32	DB15(G7)	Green data(MSB)
33	GND	Power ground
34	DB16(R0)	Red data(LSB)
35	DB17	Red data
36	DB18	Red data
37	DB19	Red data
38	DB20	Red data
39	DB21	Red data
40	DB22	Red data

41	DB23(R7)	Red data(MSB)
42	GND	Power ground

5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply voltage for analog	VCC	-0.3	6.0	V
Supply voltage for logic	VDDIO	-0.3	4.5	V
Supply current (One LED)	I _{LED}		30	mA
Operating temperature	Тор	-20	+70	С
Storage temperature	T_{ST}	-30	+80	С

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

6. Electrical Characteristics

6.1 Input Power

Item	Symbol	Min	Тур.	Max	Unit	Applicable terminal
Supply Voltage for Analog	VCC	2.5	3.8	3.6	V	
Supply Voltage for Logic	VDDIO	1.65	1.8	3.6	V	
Lanut Valtage	V_{IL}	-0.3	-	0.3VDDI O	3 7	
Input Voltage	V _{IH}	0.7 VDDIO	-	VDDIO	V	
Input leakage Current	I_{LKG}	-1		1	μΑ	

6.2 Backlight Driving Conditions

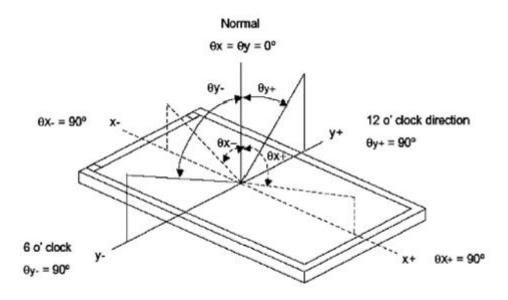
Item	Symbol		Value	Unit	Remar		
Item	Symbol	Min.	Typ.	Max.	Unit	k	
Voltage for LED Backlight	V _F	11.2	12.8	13.6	V	I _L =40mA	
Current for LED Backlight	IL		40		mA		
Power Consumption	P		0.512		W		
LED Life Time		30,000	50,000		Hr	Note	

Note: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25℃

7. Optical Characteristics

IDEA		CVADOL	COMPUTIONS	SPEC	IFICA	ΓΙΟΝS	LINITE	NOTE
ITEM		SYMBOL	CONDITIONS	MIN	TYP.	MAX	UNIT	NOTE
Luminance		L	I _L =40mA	310	350	390	cd/m ²	
Contrast l	Ratio	CR	θ=0°	650	800			
Dagnanga	Time	Ton	25℃		35	40	122 G	
Response Time		Тоғғ	23 C		33	40	ms	
	Dod			0.601	0.621	0.641		
	Red	YR	Viewing normal angle	0.324	0.344	0.364		
CIE Color –	Green	XG		0.311	0.331	0.351		
		YG		0.593	0.613	0.633		
Coordinate	Blue	Хв		0.120	0.140	0.160		
	Diue	Yв		0.053	0.073	0.093		
	White	Xw		0.277	0.297	0.317		
	winte	Yw		0.319	0.339	0.359		
	11			70	80			
Viewing Angle	$egin{array}{c} heta_{X+} \ heta_{X-} \end{array}$	CD > 10	70	80		Dagraa		
	Vor	$oldsymbol{ heta_{Y+}}$	CR≥10	70	80		Degree	
	Ver.	$ heta_{\scriptscriptstyle Y-}$		70	80			
Uniformity	Un			80			%	

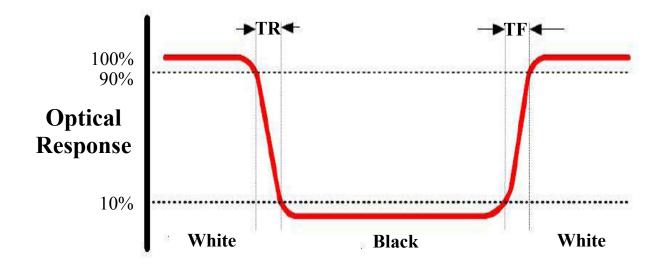
Note 1: Definition of Viewing Angle θx and θy :



Note 2: Definition of contrast ratio CR:

$$CR = \frac{Luminance of white state}{Luminance of black state}$$

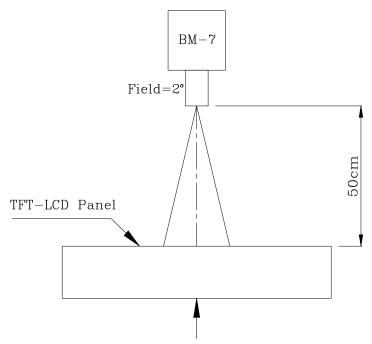
Note 3: Definition of Response Time(Tr,Tf)



Note 4: Definition of Luminance

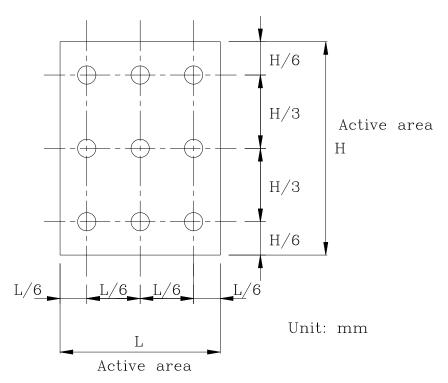
1 The Brightness Test Equipment Setup

Field=2° (As measuring "black" image, field=2° is the best testing condition)



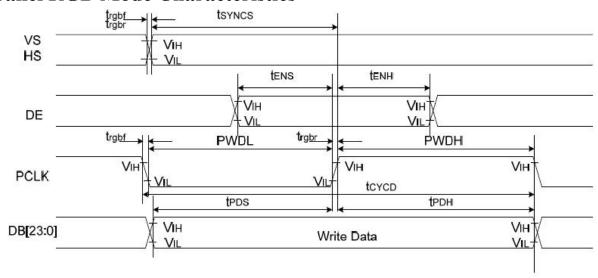
The center of the screen

②The Brightness Test Point Setup



8. Timing Characteristics

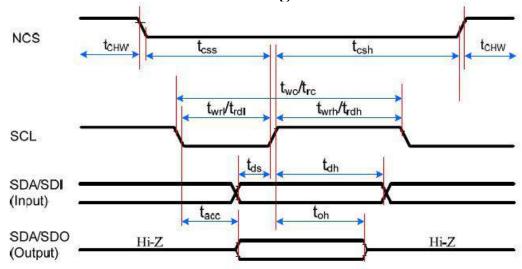
8.1 Parallel RGB Mode Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
VS/	tsyncs	VS/HS setup time	5	. W.	ns	
HS	tsynch	VS/HS hold time	5	-	ns	
DE	t _{ENS}	DE setup time	5	125	ns	
DE	tenh	DE hold time	5		ns	
DB[23:0]	tpos	Data setup time	5	19.0	ns	24/18/16-bit bus RGB
DB[23.0]	t _{PDH}	Data hold time	5	170	ns	interface mode
	PWDH	PCLK high-level period	13		ns	
DOLK	PWDL	PCLK low-level period	13	90	ns	
PCLK	tcycp	PCLK cycle time	28	353	ns	
	t _{rgbr} , t _{rgbf}	PCLK,HS,VS rise/fall time	25	15	ns	14

Note: Ta = -30 to 70 °C, IOVCC=1.65V to 3.6V, VCI=2.5V to 3.6V, DGND=0V

8.2 3-Line SPI Serial interface Timing Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
Asset for	tcss	Chip select time (Write)	15	353	ns	
CSX	tcsh	Chip select hold time (Read)	15	325	ns	S.
	tchw	CS "H" pulse width	40	9 4 8	ns	
	twc	Serial clock cycle (Write)	30	978	ns	
	twrh	SCL "H" pulse width (Write)	10	325	ns	8
601	twrl	SCL "L" pulse width (Write)	10		ns	·
SCL	trc	Serial clock cycle (Read)	150	100	ns	
	trdh	SCL "H" pulse width (Read)	60		ns	8
	trdf	SCL "L" pulse width (Read)	60	19 4 35	ns	No.
SDA/SDO	tacc	Access time (Read)	10	100	ns	For maximum CL=30pF
(Output)	toh	Output disable time (Read)	15	100	ns	For minimum CL=8pF
SDA/SDI	tds	Data setup time (Write)	10	1427	ns	
(Input)	tdh	Data hold time (Write)	10		ns	

9. Standard Specification for Reliability

9.1 Standard Specification for Reliability of LCD Module

	7.1 Standard Specification for Kenability of LCD Widdie						
No.	Item	Description	Remarks				
01	High temperature operation	The sample should be allowed to stand at 70°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.	Note 1 IEC60068-2-2, GB2423.2-89				
02	Low temperature operation	The sample should be allowed to stand at -20°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.	Note2 IEC60068-2-1 GB2423.1-89				
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.	IEC60068-2-2 GB2423.2-89				
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.	IEC60068-2-1 GB/T2423.1-89				
05	Moisture storage	The sample should be allowed to stand at $60^{\circ}\text{C},90\%\text{RH}$ MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.	IEC60068-2-1 GB/T2423.3-2006				
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles : $-30^{\circ}\text{C} \text{ for } 30 \text{ minutes} \rightarrow \text{normal temperature for 5}$ $\text{minutes} \rightarrow +80^{\circ}\text{C} \text{ for } 30 \text{ minutes} \rightarrow \text{normal}$ $\text{temperature for 5 minutes, as one cycle.}$	Start with cold temperature,end with high temperature IEC60068-2-14, GB2423.22-87				
07	Packing vibration	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.	IEC61000-2-6 GB/T2423.5-1995				
08	Packing drop test	According to ASTM-D-5327.	IEC60068-2-32 GB/T2423.8-1995				
09	Electrical Static Discharge	Air: $\pm 4 \text{KV} 150 \text{pF}/330 \Omega 5 \text{ times}$ Contact: $\pm 2 \text{KV} 150 \text{pF}/330 \Omega 5 \text{ time}$	IEC61000-4-2 GB/T17626.2-1998				

Note:1.Ts is the temperature of panel's surface.

^{2.} Ta is the ambient temperature of sample.

^{3.} Sample size for each test item is 3~5pcs.

9.2 Testing Conditions and Inspection Criteria

For the final test, the testing sample must be stored at room temperature for 24 hours. After the tests listed in Table 9.2, standard specifications for reliability will be executed in order to ensure stability.

No.	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9.3 MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($25\pm5^{\circ}$ C), normal humidity ($50\pm10\%$ RH), and in area not exposed to direct sun light.
------	--

10. Specification of Quality Assurance

This standard of Quality Assurance confirms to the quality of LCD module products supplied by ODNA.

10.1 Quality Test

Before delivering, the supplier should conduct the following tests to confirm the quality of products.

- Electrical-Optical Characteristics: According to the individual specification to test the product.
- Appearance Characteristics: According to the individual specification to test the product.
- Reliability Characteristics: According to the definition of reliability on the specification for testing products.

10.2 Delivery Test

Before delivering, the supplier should conduct the delivery test.

- Test method: According to MIL-STD105E.General Inspection Level II take a single Time.
- The defects classify of AQL as following:

Major defect: AQL = 0.65Minor defect: AQL = 2.5Total defects: AQL = 2.5

10.3 Non-conforming Analysis & Deal With Manners

10.3.1 Non-conforming Analysis

- Purchaser should provide the data detail of non-conforming sample and the non-conforming.
- After receiving the data detail from purchaser, the analysis of non-conforming should be finished within two weeks.
- If the analysis can't be finished on time, supplier must notice purchaser 3 days in advance.

10.3.2 Disposition of non-conforming

- If any product defect be found during assembling, supplier must change the good for every defect after confirmation.
- Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

10.4 Agreement items

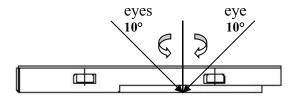
Both parties should negotiate together when the following problems happen.

- There is any problem of standard of quality assurance, and both sides should agree that it must be modified.
- There is any argument item which does not record in the standard of quality assurance.
- Any other special problem.

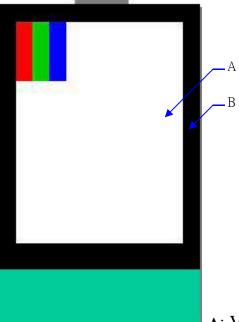
10.5 Standard of The Product Appearance Test

10.5.1 Manner of appearance test

- The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- When test the model of transmissive product must add the reflective plate.
- The test direction is base on around 10° of vertical line.
- Temperature: 25±5°C Humidity: 60±10%RH



• Definition of area:



A: Viewing area B: Outside viewing area

10.5.2 Basic principle

- When the standard can not be described, AQL will be applied.
- The sample of the lowest acceptable quality level must be negotiated by both supplier and customer when any dispute happened.

• New item must be added on time when it is necessary.

10.6 Inspection Specification

NO.	Item	Criterion			AQL	
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker 			0.65	
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	 2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm. 			2.5	
03	LCD and Touch Panel black spots, white	3.1 Round type: As follows: $\Phi = (X+Y)/2$ * Densely spaced: No		Size(mm) $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi \le 0.30$ $0.30 < \Phi$	Acceptable Q'ty Accept no dense 2 2 1 0 o spots within 3mm.	2.5
	spots, white spots, contaminati on (non – display)	3.2 Line type: (As follows: * Dens	Length(mm) L≦3.0 L≦2.5	mg) Width(mm) $W \le 0.02$ $0.02 < W \le 0.05$ $0.03 < W \le 0.08$ $0.08 < W$	Acceptable Q'ty Accept no dense	2.5

NO.	Item	Criterion			AQL
		If bubbles are visible, judge using black spot specifications, not easy	Size $Φ$ (mm) Acceptable Q'ty $Φ \le 0.20$ Accept no dense		
04	Polarizer bubbles	to find, must check in	$0.20 < \Phi \leq 0.50$	3	2.5
	bubbles	specify direction	$0.50 < \Phi \le 1.00$	2	1
			$0.50 < \Phi = 1.00$	0	1
			Total Q'ty	3	1
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass			2.5	

NO.	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function , we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle.13.2 No short circuits in components on PCB or FPC.	2.5 0.65

NO.	Item	Criterion				
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:				
		y: Chip width x: Chip length z: Chip thickness				
		$y \le 0.5 \text{mm}$ $x \le 1/8 a$ $0 < z \le t$				
07	Glass crack	Non-conductive portion:	2.5			
		y: Chip width x: Chip length z: Chip thickness				
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$				
		 If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. If the product will be heat sealed by the customer, the alignment mark must mot be damaged. 3 Substrate protuberance and internal crack 				
		$y = 1/3L \qquad X \le a$				

NO.	Item	Criterion			
14	Touch Panel Chipped glass	k: Seal width t: The L: Electrode pad leng 14.1 General glass changed 14.1.1 Chip on panel z: Chip thickness Z≦t O Unit: mm	gth	x: Chip length x ≤ 1/8a	2.5
		z: Chip thickness z≤t	y: Chip width ≤ 1/2 k and not over viewing area	x: Chip length x≤1/8a	
		⊙ Unit: mm⊙ If there are 2 or m	nore chips, x is the total l	length of each chip	

NO.	Item	Criterion		
15	Touch Panel(Fish eye dent and bubble on film)	$\begin{array}{ c c c }\hline SIZE(mm) & Acceptable Q'ty\\ \hline \Phi \leq 0.2 & Accept no dense\\ \hline 0.2 < D \leq 0.4 & 5\\ \hline 0.4 < D \leq 0.5 & 2\\ \hline 0.5 < D & 0\\ \hline \end{array}$	2.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.		
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5	
19	General appearance	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 		

11. Handling Precaution

11.1 Handling of LCM

- Avoid external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance, do not lick or swallow. When the liquid is attaching to your hand, skin, cloth, etc., wash it thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should wear protections whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface, be careful when peeling off this protective film since static electricity may be generated.

11.2 Storage

- Store it in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Store it in a clean environment, free from dust, active gas, and solvent.
- Store it in anti-static electricity container.
- Store it without any physical load.

11.3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: no higher than 280±10°C and less than 3 sec during hand soldering.
- Rewiring: no more than 2 times.

12. Packing Method

----TBD